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In data sheets, where the previous Philips references is mentioned, please use the new links as shown below.

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Thank you for your cooperation and understanding,

Ampleon

HF/VHF power MOS transistor

BLF202

FEATURES

- · High power gain
- · Easy power control
- · Gold metallization
- · Good thermal stability
- · Withstands full load mismatch.

APPLICATIONS

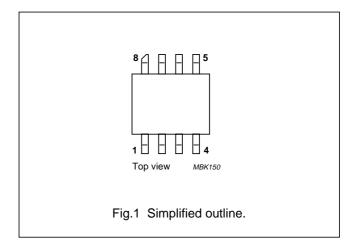
 Communications transmitters in the HF/VHF range with a nominal supply voltage of 12.5 V.

DESCRIPTION

Silicon N-channel enhancement mode vertical D-MOS transistor in an 8-lead SOT409A SMD package with a ceramic cap.

PINNING - SOT409A

| PIN | DESCRIPTION |
|------|-------------|
| 1, 8 | source |
| 2, 3 | gate |
| 4, 5 | source |
| 6, 7 | drain |



QUICK REFERENCE DATA

RF performance at T_{mb} = 25 °C in a common source test circuit.

| MODE OF OPERATION | f | V _{DS} | P _L | G _p | η _D |
|-------------------|-------|-----------------|----------------|----------------|----------------|
| | (MHz) | (V) | (W) | (dB) | (%) |
| CW, class-B | 175 | 12.5 | 2 | >10 | >50 |

CAUTION

This product is supplied in anti-static packing to prevent damage caused by electrostatic discharge during transport and handling. For further information, refer to Philips specs.: SNW-EQ-608, SNW-FQ-302A, and SNW-FQ-302B.

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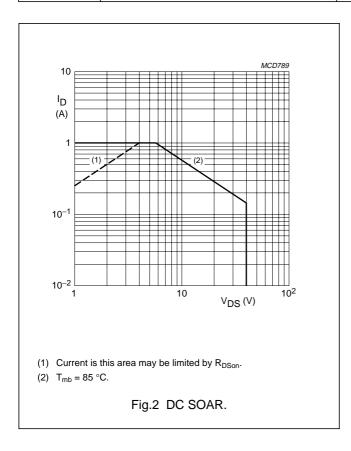
LIMITING VALUES

In accordance with the Absolute Maximum System (IEC 60134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|------------------|-------------------------|-------------------------|------|------|------|
| V _{DS} | drain-source voltage | | _ | 40 | V |
| V _{GS} | gate-source voltage | | _ | ±20 | V |
| I _D | drain current (DC) | | _ | 1 | Α |
| P _{tot} | total power dissipation | T _{mb} ≤ 85 °C | _ | 5.7 | W |
| T _{stg} | storage temperature | | -65 | 150 | °C |
| Tj | junction temperature | | _ | 200 | °C |

THERMAL CHARACTERISTICS

| SYMBOL | PARAMETER | CONDITIONS | VALUE | UNIT |
|----------------------|-------------------------------------|---------------------------------------|-------|------|
| R _{th j-mb} | thermal resistance from junction to | $T_{mb} \le 85$ °C; $P_{tot} = 5.7$ W | 20.5 | K/W |
| | mounting base | | | |



HF/VHF power MOS transistor

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CHARACTERISTICS

 $T_j = 25$ °C unless otherwise specified.

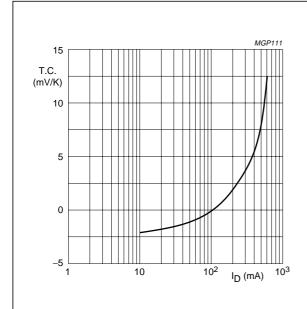
| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|----------------------|----------------------------------|--|------|------|------|------|
| V _{(BR)DSS} | drain-source breakdown voltage | $I_D = 3 \text{ mA}; V_{GS} = 0$ | 40 | _ | _ | ٧ |
| V_{GSth} | gate-source threshold voltage | $I_D = 3 \text{ mA}; V_{DS} = 10 \text{ V}$ | 2 | _ | 4.5 | ٧ |
| I _{DSS} | drain-source leakage current | V _{GS} = 0; V _{DS} = 12.5 V | _ | _ | 10 | μΑ |
| I _{GSS} | gate-source leakage current | $V_{GS} = \pm 20 \text{ V}; V_{DS} = 0$ | _ | _ | 1 | μΑ |
| I _{DSX} | on-state drain current | V _{GS} = 15 V; V _{DS} = 10 V | _ | 1.3 | _ | Α |
| R _{DSon} | drain-source on-state resistance | $I_D = 0.3 \text{ A}; V_{GS} = 15 \text{ V}$ | _ | 3.5 | 4 | Ω |
| 9fs | forward transconductance | I _D = 0.3 A; V _{DS} = 10 V | 80 | 135 | _ | mS |
| C _{is} | input capacitance | $V_{GS} = 0$; $V_{DS} = 12.5 \text{ V}$; $f = 1 \text{ MHz}$ | _ | 5.3 | _ | pF |
| C _{os} | output capacitance | $V_{GS} = 0$; $V_{DS} = 12.5 \text{ V}$; $f = 1 \text{ MHz}$ | _ | 7.8 | _ | pF |
| C _{rs} | feedback capacitance | $V_{GS} = 0$; $V_{DS} = 12.5 \text{ V}$; $f = 1 \text{ MHz}$ | _ | 1.8 | _ | pF |

V_{GS} group indicator

| GROUP | LIM (\ | | GROUP | LIMITS (V) | | |
|-------|-----------|------|-------|---------------|------|--|
| | MIN. | MAX. | | MIN. | MAX. | |
| А | 2.0 | 2.1 | 0 | 3.3 | 3.4 | |
| В | 2.1 | 2.2 | Р | 3.4 | 3.5 | |
| С | 2.2 | 2.3 | Q | 3.5 | 3.6 | |
| D | 2.3 | 2.4 | R | 3.6 | 3.7 | |
| E | 2.4 | 2.5 | S | 3.7 | 3.8 | |
| F | 2.5 | 2.6 | Т | 3.8 | 3.9 | |
| G | 2.6 | 2.7 | U | 3.9 | 4.0 | |
| Н | 2.7 | 2.8 | V | 4.0 | 4.1 | |
| J | 2.8 | 2.9 | W | 4.1 | 4.2 | |
| K | 2.9 | 3.0 | X | 4.2 | 4.3 | |
| L | 3.0 | 3.1 | Y | 4.3 | 4.4 | |
| M | 3.1 | 3.2 | Z | 4.4 | 4.5 | |
| N | 3.2 | 3.3 | | | | |

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 $V_{DS} = 10 \text{ V}.$

Fig.3 Temperature coefficient of gate-source voltage as a function of drain current; typical values.

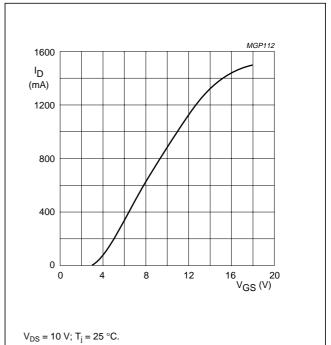
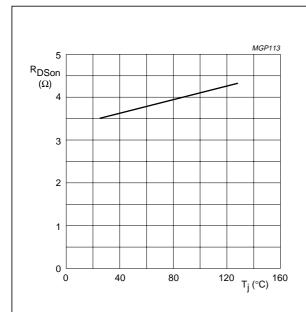


Fig.4 Drain current as a function of gate-source voltage; typical values.



 $V_{GS} = 15 \text{ V}; I_D = 0.3 \text{ A}.$

Fig.5 Drain-source on-state resistance as a function of junction temperature; typical values.

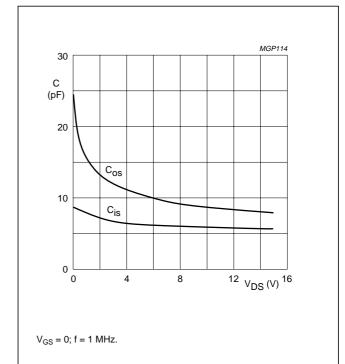
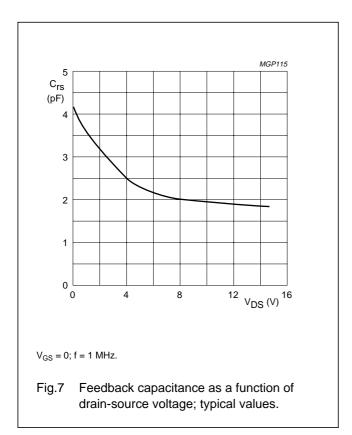


Fig.6 Input and output capacitance as functions of drain-source voltage; typical values.

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APPLICATION INFORMATION FOR CLASS-B OPERATION

 T_{mb} = 25 °C; R_{GS} = 237 Ω ; unless otherwise specified.

RF performance in CW operation in a common source class-B test circuit.

| MODE OF OPERATION | f (MHz) | V _{DS} (V) | I _{DQ} (mA) | P _L (W) | G _p (dB) | η _D (%) |
|-------------------|------------|---------------------|-------------------------|-----------------------|------------------------|-----------------------|
| CW, class-B | 175 | 12.5 | 20 | 2 | >10 | >50 |
| | | | | | typ. 13 | typ. 55 |

Ruggedness in class-B operation

The BLF202 is capable of withstanding a load mismatch corresponding to VSWR = 50:1 through all phases under the following conditions: $V_{DS} = 15.5 \text{ V}$; f = 175 MHz at rated load power.

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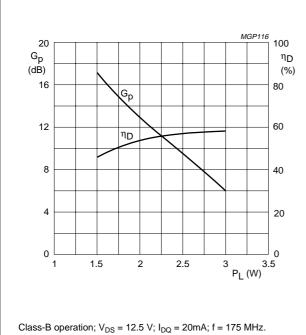
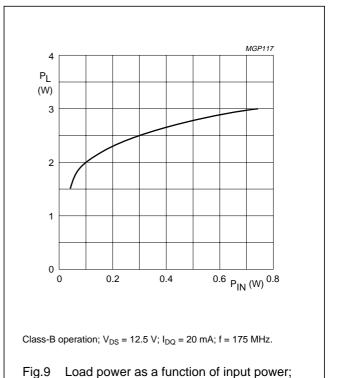
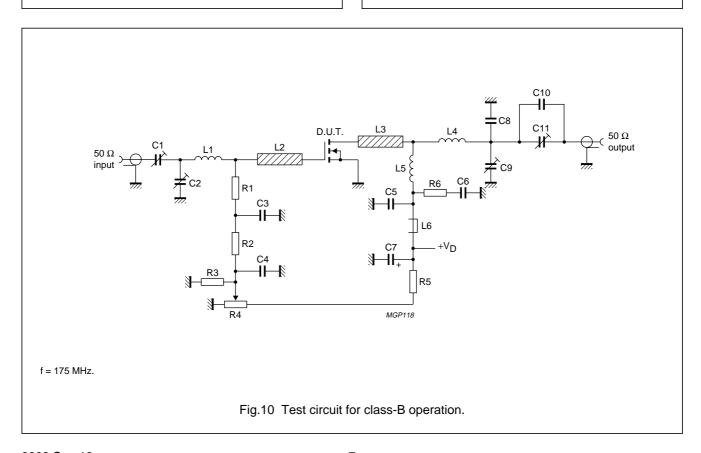


Fig.8 Power gain and efficiency as a functions of load power; typical values.



typical values.



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List of components (see Fig.10)

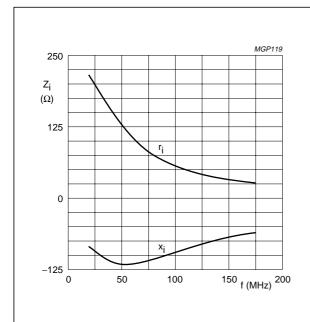
| COMPONENT | DESCRIPTION | VALUE | DIMENSIONS | CATALOGUE NO. |
|-----------|---|------------------------------------|---|----------------|
| C1, C11 | film dielectric trimmer | 2 to 9 pF | | 2222 809 09005 |
| C2, C9 | film dielectric trimmer | 2 to 9 pF | | 2222 809 09002 |
| C3, C5 | multilayer ceramic chip capacitor; note 1 | 1 nF; 500 V | | |
| C4, C6 | multilayer ceramic chip capacitor | 2 × 100 nF in parallel, 50 V | | 2222 852 47104 |
| C7 | Sprague electrolytic tantalum capacitor | 2.2 μF; 35 V | | |
| C8 | multilayer ceramic chip capacitor; note 1 | 5.1 pF; 500 V | | |
| C10 | multilayer ceramic chip capacitor; note 1 | 9.1 pF; 500 V | | |
| L1 | 8 turns enamelled 0.8 mm copper wire | 137 nH | length 5.1 mm; int. dia. 4 mm; leads 2 × 5 mm | |
| L2, L3 | stripline; note 2 | 81 Ω | 8 mm × 2 mm | |
| L4 | 3 turns enamelled 1 mm copper wire | 57 nH | length 5 mm; int. dia. 6 mm; leads 2 × 5 mm | |
| L5 | 9 turns enamelled 1 mm copper wire | 355 nH | length 11 mm; int. dia. 7 mm; leads 2 × 5 mm | |
| L6 | grade 3B Ferroxcube RF choke | | | 4312 020 36642 |
| R1 | 0.4 W metal film resistor | 237 Ω | | 2322 151 72371 |
| R2 | 0.4 W metal film resistor | 1 kΩ | | 2322 151 71002 |
| R3 | 0.4 W metal film resistor | 1 ΜΩ | | 2322 151 71005 |
| R4 | 10 turns cermet potentiometer | 5 kΩ | | |
| R5 | 0.4 W metal film resistor | 7.5 kΩ | | 2322 151 77502 |
| R6 | 1 W metal film resistor | 10 Ω | | 2322 153 51009 |

Notes

- 1. American Technical Ceramics (ATC) capacitor, type 100B or other capacitor of the same quality.
- 2. The striplines are on a double copper-clad printed-circuit board, with PTFE fibre-glass dielectric (ϵ_r = 2.2), thickness 1.6 mm.

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Class B-operation; V_{DS} = 12.5 V; I_{DQ} = 20 mA; R_{GS} = 237 Ω ; P_L = 2 W.

Fig.11 Input impedance as a function of frequency (series of components); typical values.

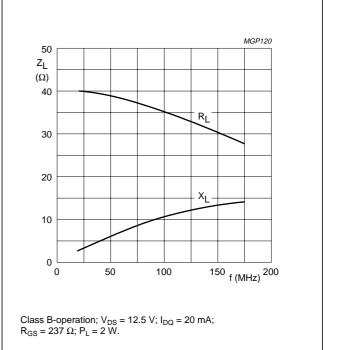
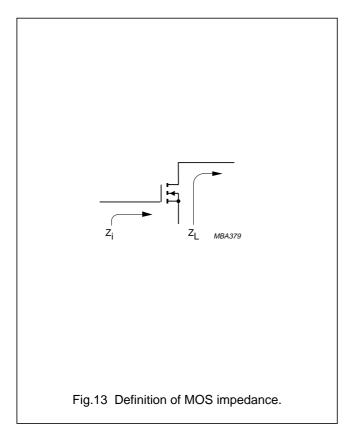
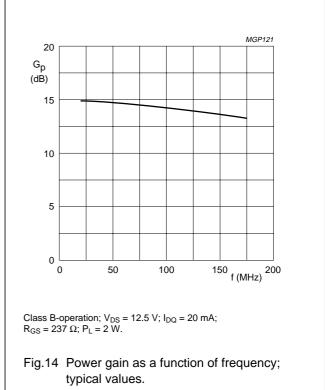


Fig.12 Load impedance as a function of frequency (series components); typical values.





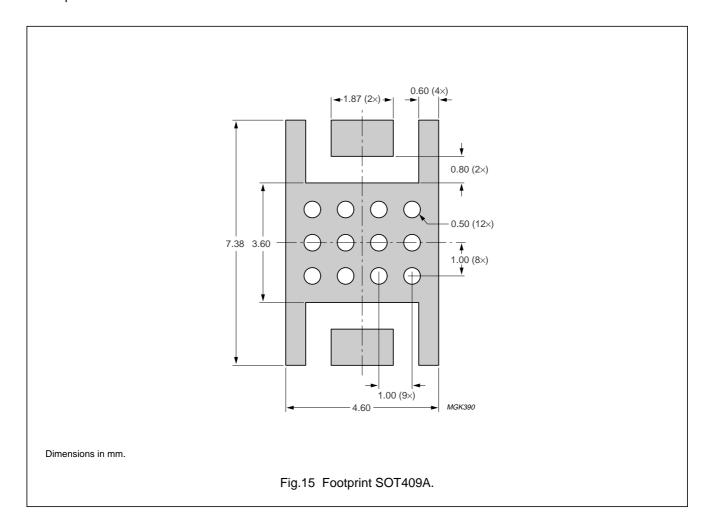
HF/VHF power MOS transistor

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MOUNTING RECOMMENDATIONS

Both the metallized ground plate and the device leads contribute to the heat flow. It is recommended that the transistor be mounted on a grounded metallized area of the printed-circuit board. This area should be of maximum 0.8 mm thickness and include at least 12 x 0.5 diameter through metallized holes filled with solder.

A thermal resistance $R_{th(mb-h)}$ of 5 K/W can be achieved if heatsink compound is applied when the transistor is mounted on the printed-circuit board.



HF/VHF power MOS transistor

BLF202

BLF202 scattering parameters

 $V_{DS} = 12.5 \text{ V}; I_D = 20 \text{ mA}; \text{ note 1}$

| f (MHz) | | s ₁₁ | | 21 | S ₁ | 2 | s ₂₂ | | |
|------------|-----------------|-----------------|-----------------|---------|-----------------|-------|-----------------|---------|--|
| 1 (IVIII2) | s ₁₁ | ∠Φ | s ₂₁ | ∠Φ | s ₁₂ | ∠Φ | s ₂₂ | ∠Φ | |
| 5 | 1.00 | -2.00 | 5.76 | 178.30 | 0.01 | 88.30 | 0.97 | -2.40 | |
| 10 | 1.00 | -4.00 | 5.75 | 176.50 | 0.01 | 86.70 | 0.97 | -4.90 | |
| 20 | 1.00 | -7.90 | 5.72 | 172.90 | 0.02 | 83.40 | 0.97 | -9.70 | |
| 30 | 0.99 | -11.90 | 5.69 | 169.40 | 0.03 | 80.20 | 0.97 | -14.50 | |
| 40 | 0.99 | -15.80 | 5.65 | 165.90 | 0.04 | 77.00 | 0.96 | -19.30 | |
| 50 | 0.98 | -19.60 | 5.58 | 162.40 | 0.05 | 73.80 | 0.96 | -23.90 | |
| 60 | 0.97 | -23.40 | 5.51 | 159.00 | 0.06 | 70.70 | 0.95 | -28.50 | |
| 70 | 0.96 | -27.00 | 5.42 | -155.70 | 0.07 | 67.70 | 0.94 | -33.00 | |
| 80 | 0.94 | -30.70 | 5.33 | 152.40 | 0.08 | 64.80 | 0.93 | -37.40 | |
| 90 | 0.93 | -34.10 | 5.23 | 149.30 | 0.09 | 62.00 | 0.92 | -41.60 | |
| 100 | 0.92 | -37.50 | 5.12 | 146.40 | 0.10 | 59.40 | 0.92 | -45.60 | |
| 125 | 0.89 | -45.60 | 4.86 | 139.30 | 0.12 | 53.10 | 0.89 | -55.30 | |
| 150 | 0.85 | -53.00 | 4.58 | 132.60 | 0.13 | 47.20 | 0.87 | -64.10 | |
| 175 | 0.82 | -59.80 | 4.29 | 126.60 | 0.14 | 42.00 | 0.85 | -72.00 | |
| 200 | 0.79 | -66.00 | 4.03 | 121.20 | 0.15 | 37.70 | 0.83 | -79.20 | |
| 250 | 0.74 | -77.00 | 3.55 | 111.30 | 0.17 | 29.30 | 0.79 | -91.70 | |
| 300 | 0.70 | -86.30 | 3.15 | 103.30 | 0.17 | 23.10 | 0.77 | -101.90 | |
| 350 | 0.68 | -94.30 | 2.80 | 96.00 | 0.18 | 17.30 | 0.76 | -110.30 | |
| 400 | 0.66 | -101.40 | 2.52 | 89.80 | 0.18 | 12.90 | 0.75 | -117.20 | |
| 450 | 0.64 | -107.80 | 2.27 | 83.80 | 0.18 | 8.60 | 0.74 | -123.20 | |
| 500 | 0.64 | -113.50 | 2.07 | 78.80 | 0.18 | 5.20 | 0.74 | -128.30 | |
| 600 | 0.63 | -123.80 | 1.75 | 69.60 | 0.17 | -0.70 | 0.74 | -136.60 | |
| 700 | 0.64 | -132.60 | 1.51 | 61.40 | 0.15 | -5.30 | 0.75 | -143.20 | |
| 800 | 0.65 | -140.60 | 1.32 | 54.40 | 0.14 | -8.20 | 0.76 | -148.60 | |
| 900 | 0.67 | -148.10 | 1.16 | 48.20 | 0.12 | -9.70 | 0.77 | -153.30 | |
| 1000 | 0.68 | -155.00 | 1.04 | 42.90 | 0.11 | -9.20 | 0.78 | -157.40 | |

Note

^{1.} For more extensive s-parameters see internet: http://www.semiconductors.philips.com/markets/communications/wirelesscommunications/broadcast.

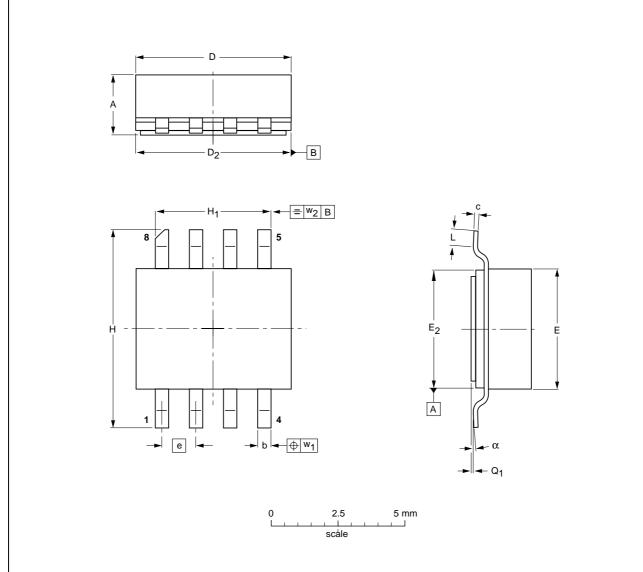
HF/VHF power MOS transistor

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PACKAGE OUTLINE

Ceramic surface mounted package; 8 leads

SOT409A



DIMENSIONS (millimetre dimensions are derived from the original inch dimensions)

| UNIT | A | b | C | D | D ₂ | E | E ₂ | е | н | Н1 | L | Q ₁ | w ₁ | w ₂ | α |
|--------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|-------|----------------|----------------|----------------|----------------|----------------|----------------|----------|
| mm | 2.36 2.06 | 0.58 0.43 | 0.23 0.18 | 5.94 5.03 | 5.16 5.00 | 4.93 4.01 | 4.14 3.99 | 1.27 | 7.47 7.26 | 4.39 4.24 | 1.02 0.51 | 0.10 0.00 | 0.25 | 0.25 | 7° 0° |
| inches | 0.093 0.081 | 0.023 0.017 | 0.009 0.007 | 0.234 0.198 | 0.203 0.197 | 0.194 0.158 | 0.163 0.157 | 0.050 | 0.294 0.286 | 0.173 0.167 | 0.040 0.020 | 0.004 0.000 | 0.010 | 0.010 | 7° 0° |

| OUTLINE | | REFER | EUROPEAN | ISSUE DATE | | | |
|---------|-----|-------|-------------|------------|------------|------------|--|
| VERSION | IEC | JEDEC | BBO JECTION | | PROJECTION | ISSUE DATE | |
| SOT409A | | | | | | 98-01-27 | |

HF/VHF power MOS transistor

BLF202

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|-------|-------------------------------------|-------------------------------------|--|
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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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